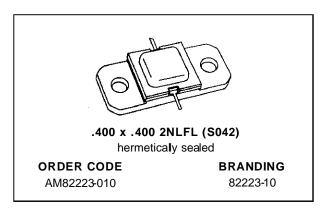


AM82223-010

RF & MICROWAVE TRANSISTORS TELEMETRY APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- ∞:1 VSWR CAPABILITY AT RATED CONDITIONS
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- Pout = 9 W MIN. WITH 6.5 dB GAIN

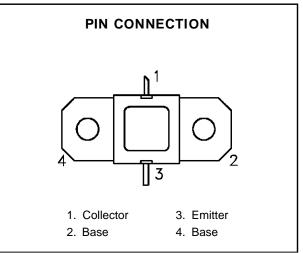


DESCRIPTION

The AM82223-010 is a common base, silicon NPN bipolar transistor designed for high gain and efficiency in the 2.2 – 2.3 GHz frequency range.

Suitable for hi-rel aerospace telemetry applications, the AM82223-010 is provided in the industry-standard AMPACTM metal/ceramic hermetic package and incorporates internal input and output impedance matching structures along with a rugged, emitter-site ballasted overlay die geometry.

AM82223-010 is capable of withstanding ∞ :1 load mismatch at any phase angle under full rated operating conditions.



ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
Poiss	Power Dissipation* (T _C ≤ 75°C)	28	W
Ic	Device Current*	1.2	А
Vcc	Collector-Supply Voltage*	26	V
TJ	Junction Temperature	200	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

ſ	$R_{TH(j-c)}$	Junction-Case Thermal Resistance	4.4	°C/W

*Applies only to rated RF amplifier operation

NOTE: Thermal Resistance determined by Infra-Red Scanning of Hot-Spot Junction Temperature at rated RF operating conditions.

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AM82223-010

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

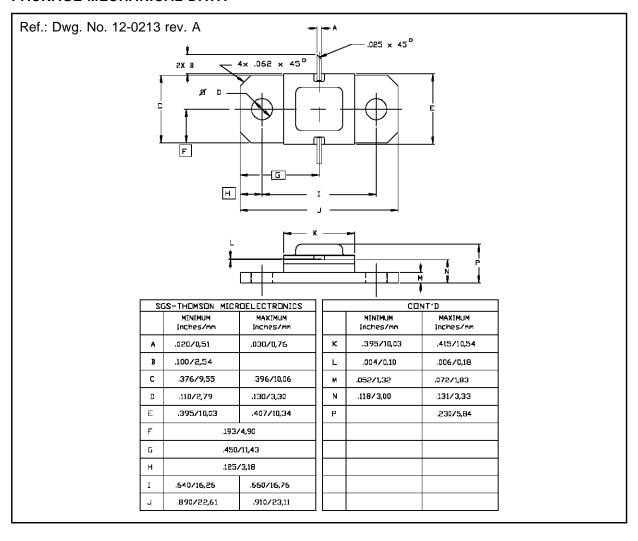
STATIC

Symbol	Test Conditions		Value			Unit	
				Min. Typ. Max.		Max.	
BV _{CBO}	I _C = 5 mA	$I_E = 0 \text{ mA}$		45			V
BVcer	I _C = 10 mA	$R_{BE} = 10 \Omega$		45	_	_	V
BV _{EBO}	I _E = 1 mA	$I_C = 0 \text{ mA}$		3.5	_		V
Ісво	V _{CB} = 24 V			_	_	1	mA
h _{FE}	V _{CE} = 5 V	I _C = 750 mA		20	_	300	_

DYNAMIC

Symbol	Toot Conditions		Value			IImi4	
Symbol	Test Conditions			Min.	Тур.	Max.	Unit
Pout	f = 2.2 – 2.3 GHz	$P_{IN}=2.0\;W$	$V_{CC} = 24 \text{ V}$	9.0	_	_	W
ης	f = 2.2 – 2.3 GHz	$P_{IN} = 2.0 \text{ W}$	$V_{CC} = 24 V$	40	_	_	%
PG	f = 2.2 – 2.3 GHz	P _{IN} = 2.0 W	Vcc = 24 V	6.5	_	_	dB

PACKAGE MECHANICAL DATA



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